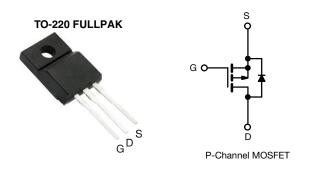
IRFI9Z24G

Vishay Siliconix



Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V)	-60)
R _{DS(on)} (Ω)	V _{GS} = -10 V	0.28
Q _g (Max.) (nC)	19	
Q _{gs} (nC)	5.4	
Q _{gd} (nC)	11	
Configuration	Sing	le

FEATURES

- Isolated package
- High voltage isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)



- Sink to lead creepage distance = 4.8 mm
- P-channel
- 175 °C operating temperature
- Dynamic dV/dt rating
- Low thermal resistance
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFI9Z24GPbF

ABSOLUTE MAXIMUM RATINGS T _C :	= 25 °C, unle	ess otherwis	e noted		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	-60	V
Gate-source voltage			V _{GS}	± 20	v
Continuous drain current	V === 10.V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		-8.5	
	VGS at -10 V	$T_C = 100 \ ^\circ C$	I _D	-6.0	А
Pulsed drain current ^a			I _{DM}	-34	
Linear derating factor				0.24	W/°C
Single pulse avalanche energy ^b			E _{AS}	200	mJ
Repetitive avalanche current ^a			I _{AR}	-8.5	А
Repetitive avalanche energy ^a			E _{AR}	3.7	mJ
Maximum power dissipation	T _C =	25 °C	PD	37	W
Peak diode recovery dV/dt ^c			dV/dt	-4.5	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) ^d	For 10 s			300	
Mounting torque	6-32 or M3 screw			10	lbf · in
Mounting torque				1.1	N · m

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = -25 V, starting T_J = 25 °C, L = 3.2 mH, R_G = 25 Ω , I_{AS} = -8.5 A (see fig. 12)

c. $I_{SD} \leq$ -11 A, dl/dt \leq 140 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq$ 175 °C

d. 1.6 mm from case

S21-0471-Rev. B, 17-May-2021

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PARAMETER	SYMBOL	TYP		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	- 65			UNIT			
Maximum junction-to-case (drain)		- 65				°C/W		
	R _{thJC}	- 4.1						
SPECIFICATIONS T _J = 25 °C, u	nless otherwi	se noted						
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static		•						
Drain-ssource breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = -2	250 μΑ	-60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I	l _D = -1 mA	-	-0.056	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = -2$	250 µA	-2.0	-	-4.0	V
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 20$	V	-	-	± 100	nA
		V _{DS} =	= -60 V, V _{GS}	= 0 V	-	-	-100	μA
Zero gate voltage drain current	IDSS	V _{DS} = -48	V _{GS} = 0 V, ⁻	Г _Ј = 150 °С	-	-	-500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = -10 V	I _D =	= -5.1 A ^b	-	-	0.28	Ω
Forward transconductance	9 _{fs}	V _{DS} =	-25 V, I _D = -	-5.1 A ^b	3.2	-	-	S
Dynamic		•						
Input capacitance	C _{iss}	N 0.V			-	570	-	- pF
Output capacitance	Coss	$V_{GS} = 0 V, V_{DS} = -25 V, f = 1.0 MHz, see fig. 5 f = 1.0 MHz$		-	360	-		
Reverse transfer capacitance	C _{rss}			-	65	-		
Drain to sink capacitance	С			-	12	-		
Total gate charge	Qg			-	-	19		
Gate-source charge	Q _{gs}	$V_{GS} = -10 V$		A, V _{DS} = -48 V, J. 6 and 13 ^b	-	-	5.4	nC
Gate-drain charge	Q _{gd}		000 119		-	-	11	
Turn-on delay time	t _{d(on)}				-	13	-	
Rise time	t _r		-30 V, I _D =		-	68	-	1
Turn-off delay time	t _{d(off)}	R _G = 18 Ω, R _D = 2.5 Ω, see fig. 10 ^b		-	15	-	ns	
Fall time	t _f		-		-	29	-	1
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal source inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs	•						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	-8.5	A	
Pulsed diode forward current ^a	I _{SM}			-	-	-34		
Body diode voltage	V_{SD}	T_J = 25 °C, I_S = -8.5 A, V_{GS} = 0 V $^{\rm b}$		$V_{GS} = 0 V^{b}$	-	-	-6.3	V
Body diode reverse recovery time	t _{rr}	$T_{\rm J} = 25~{\rm °C}, I_{\rm F} = -11~{\rm A}, dl/dt = 100~{\rm A}/\mu{\rm s}^{{\rm b}}$		dt - 100 A/up b	-	100	200	ns
Body diode reverse recovery charge	Q _{rr}			-	0.32	0.64	μC	
Forward turn-on time	t _{on}	Intrinsic tu	rn-on time	is negligible (turn	-on is dor	ninated h	vlaand	1 -)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

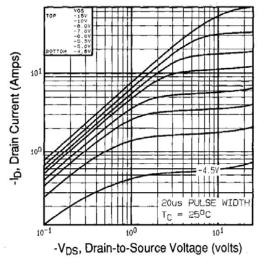


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

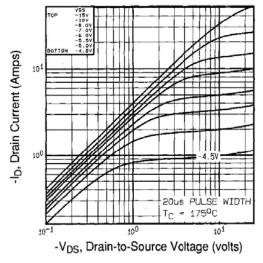


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

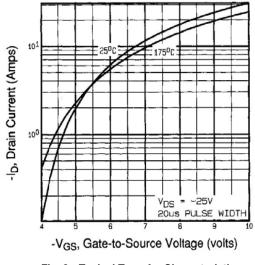


Fig. 3 - Typical Transfer Characteristics

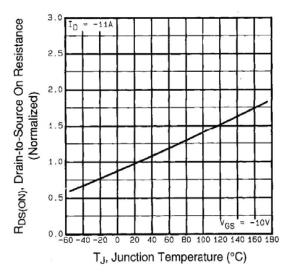


Fig. 4 - Normalized On-Resistance vs. Temperature



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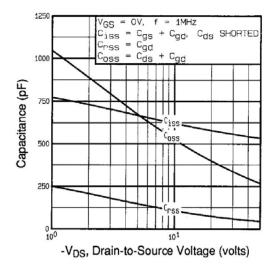
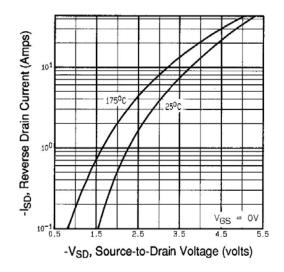


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





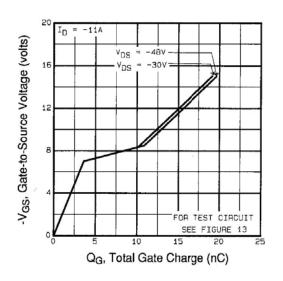


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

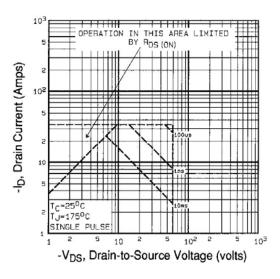


Fig. 8 - Maximum Safe Operating Area

4



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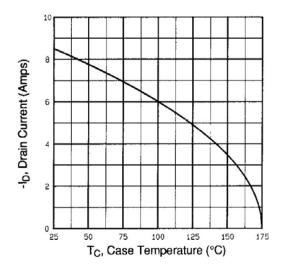


Fig. 9 - Maximum Drain Current vs. Case Temperature

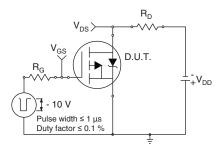


Fig. 10a - Switching Time Test Circuit

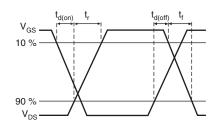


Fig. 10b - Switching Time Waveforms

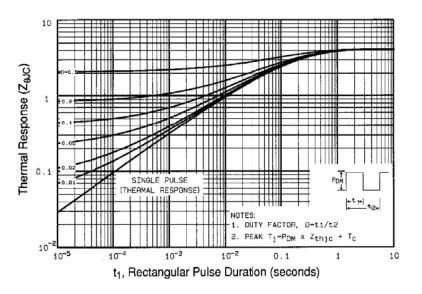


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



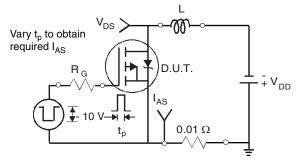
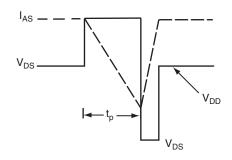


Fig. 12a - Unclamped Inductive Test Circuit



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Fig. 12b - Unclamped Inductive Waveforms

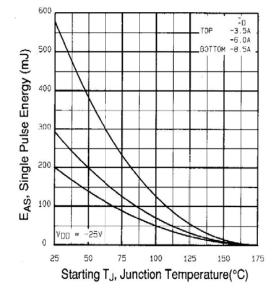


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

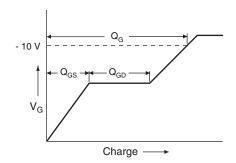


Fig. 13a - Basic Gate Charge Waveform

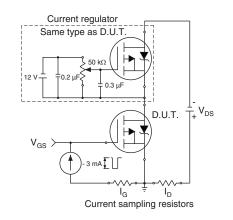


Fig. 13b - Gate Charge Test Circuit

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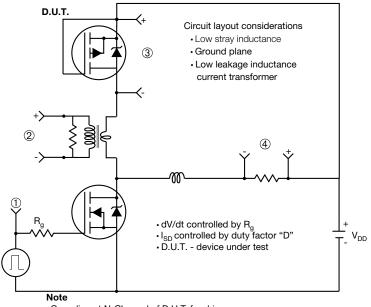
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Peak Diode Recovery dV/dt Test Circuit



· Compliment N-Channel of D.U.T. for driver

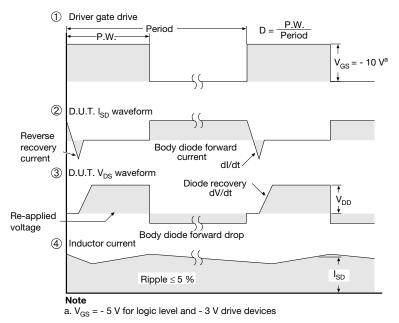


Fig. 14 - For P-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

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